74LVC1G384

Bilateral switch
Rev. 4 — 6 December 2011

Product data sheet

1. **General description**

The 74LVC1G384 provides one single pole, single throw analog switch function. It has two input/output terminals (Y and Z) and an active LOW enable input pin (E). When pin E is HIGH, the analog switch is turned off.

Schmitt trigger action at the enable input makes the circuit tolerant of slower input rise and fall times across the entire V_{CC} range from 1.65 V to 5.5 V.

2. **Features and benefits**

- Wide supply voltage range from 1.65 V to 5.5 V
- Very low ON resistance:
 - 7.5 Ω (typical) at $V_{CC} = 2.7 \text{ V}$
 - 6.5 Ω (typical) at $V_{CC} = 3.3 \text{ V}$
 - 6 Ω (typical) at $V_{CC} = 5 \text{ V}$
- ESD protection:
 - ♦ HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Switch current capability of 32 mA
- High noise immunity
- CMOS low power consumption
- TTL interface compatibility at 3.3 V
- Latch-up performance meets requirements of JESD 78 Class I
- Enable input accepts voltages up to 5.5 V
- Inputs accept voltages up to 5 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. **Ordering information**

Table 1. **Ordering information**

| Type number | Package | | | |
|--------------|-------------------|--------|---|----------|
| | Temperature range | Name | Description | Version |
| 74LVC1G384GW | –40 °C to +125 °C | TSSOP5 | plastic thin shrink small outline package; 5 leads; body width 1.25 mm | SOT353-1 |
| 74LVC1G384GV | –40 °C to +125 °C | SC-74A | plastic surface-mounted package; 5 leads | SOT753 |
| 74LVC1G384GM | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1.45 \times 0.5 mm | SOT886 |



 Table 1.
 Ordering information ...continued

| Type number | Package | | | |
|--------------|-------------------|-------|--|---------|
| | Temperature range | Name | Description | Version |
| 74LVC1G384GF | –40 °C to +125 °C | XSON6 | plastic extremely thin small outline package; no leads; 6 terminals; body 1 \times 1 \times 0.5 mm | SOT891 |
| 74LVC1G384GN | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm | SOT1115 |
| 74LVC1G384GS | –40 °C to +125 °C | XSON6 | extremely thin small outline package; no leads; 6 terminals; body 1.0 \times 1.0 \times 0.35 mm | SOT1202 |

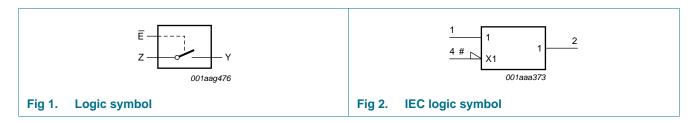
4. Marking

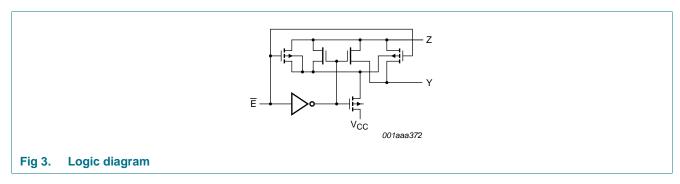
Table 2. Marking

| ······································ | |
|--|-----------------------------|
| Type number | Marking code ^[1] |
| 74LVC1G384GW | YL |
| 74LVC1G384GV | YL |
| 74LVC1G384GM | YL |
| 74LVC1G384GF | YL |
| 74LVC1G384GN | YL |
| 74LVC1G384GS | YL |

^[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

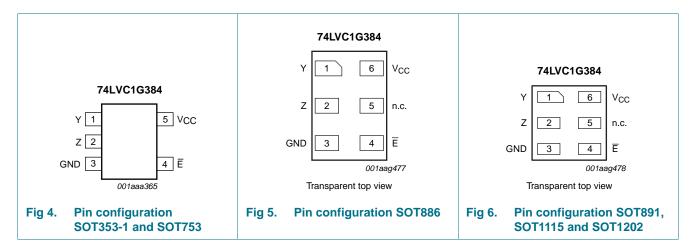
5. Functional diagram





6. Pinning information

6.1 Pinning



6.2 Pin description

Table 3. Pin description

| Symbol | Pin | | Description | |
|-----------------|------------------|-------------------------------------|-----------------------------|--|
| | SOT353-1, SOT753 | SOT886, SOT891, SOT1115 and SOT1202 | | |
| Υ | 1 | 1 | independent input or output | |
| Z | 2 | 2 | independent output or input | |
| GND | 3 | 3 | ground (0 V) | |
| Ē | 4 | 4 | enable input (active LOW) | |
| n.c. | - | 5 | not connected | |
| V _{CC} | 5 | 6 | supply voltage | |

7. Functional description

Table 4. Function table[1]

| Input E | Switch |
|---------|-----------|
| L | ON-state |
| Н | OFF-state |

^[1] H = HIGH voltage level; L = LOW voltage level.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|---|-----------------|----------------|------|
| V_{CC} | supply voltage | | -0.5 | +6.5 | V |
| V _I | input voltage | | <u>[1]</u> –0.5 | +6.5 | V |
| I _{IK} | input clamping current | $V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$ | -50 | - | mA |
| I _{SK} | switch clamping current | $V_I < -0.5 \text{ V or } V_I > V_{CC} + 0.5 \text{ V}$ | - | ±50 | mA |
| V _{SW} | switch voltage | enable and disable mode | <u>[2]</u> –0.5 | $V_{CC} + 0.5$ | V |
| I_{SW} | switch current | V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V | - | ±50 | mA |
| I _{CC} | supply current | | - | 100 | mA |
| I_{GND} | ground current | | -100 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | $T_{amb} = -40 ^{\circ} ^{\circ} C \text{ to } +125 ^{\circ} C$ | [3] _ | 250 | mW |

^[1] The minimum input voltage rating may be exceeded if the input current rating is observed.

9. Recommended operating conditions

Table 6. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------|---------------------------|---|--------------|-----|----------|------|
| V_{CC} | supply voltage | | 1.65 | - | 5.5 | V |
| VI | input voltage | | 0 | - | 5.5 | V |
| V _{SW} | switch voltage | | <u>[1]</u> 0 | - | V_{CC} | V |
| T _{amb} | ambient temperature | | -40 | - | +125 | °C |
| Δt/ΔV | input transition rise and | $V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$ | - | - | 20 | ns/V |
| | fall rate | $V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$ | - | - | 10 | ns/V |

^[1] To avoid sinking GND current from terminal Z when switch current flows in terminal Y, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no GND current will flow from terminal Y. In this case, there is no limit for the voltage drop across the switch.

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^[2] The minimum and maximum switch voltage ratings may be exceeded if the switch clamping current rating is observed.

^[3] For TSSOP5 and SC-74A packages: above 87.5 °C the value of P_{tot} derates linearly with 4.0 mW/K. For XSON6 package: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

10. Static characteristics

Table 7. Static characteristics

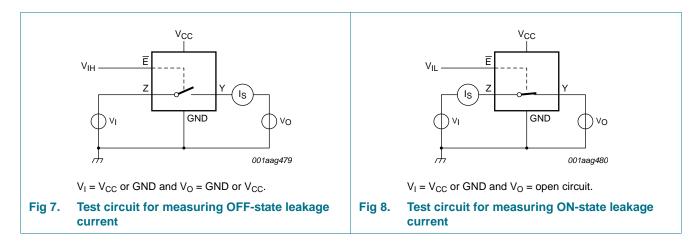
At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | | -40 ° | C to +8 | 5 °C | –40 °C to | +125 °C | Unit |
|---------------------|---------------------------------|--|-----|---------------------|---------|--------------|----------------------|--------------|---------------|
| | | | | Min | Typ[1] | Max | Min | Max | |
| V_{IH} | HIGH-level | V _{CC} = 1.65 V to 1.95 V | | 0.65V _{CC} | - | - | 0.65 V _{CC} | - | V |
| | input voltage | V _{CC} = 2.3 V to 2.7 V | | 1.7 | - | - | 1.7 | - | V |
| | | V _{CC} = 2.7 V to 3.6 V | | 2.0 | - | - | 2.0 | - | V |
| | | V _{CC} = 4.5 V to 5.5 V | | $0.7V_{CC}$ | - | - | $0.7V_{CC}$ | - | V |
| V_{IL} | LOW-level | V _{CC} = 1.65 V to 1.95 V | | - | - | $0.35V_{CC}$ | - | $0.35V_{CC}$ | V |
| | input voltage | V _{CC} = 2.3 V to 2.7 V | | - | - | 0.7 | - | 0.7 | V |
| | | V _{CC} = 2.7 V to 3.6 V | | - | - | 0.8 | - | 0.8 | V V V V C V V |
| | | V _{CC} = 4.5 V to 5.5 V | | - | - | $0.3V_{CC}$ | - | $0.3V_{CC}$ | V |
| II | input leakage current | pin \overline{E} ; V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V | [2] | - | ±0.1 | ±5 | - | 100 | μА |
| I _{S(OFF)} | OFF-state leakage current | V _{CC} = 5.5 V; see <u>Figure 7</u> | [2] | - | ±0.1 | ±5 | - | 200 | μА |
| I _{S(ON)} | ON-state leakage current | V _{CC} = 5.5 V; see <u>Figure 8</u> | [2] | - | ±0.1 | ±5 | - | 200 | μА |
| I _{CC} | supply current | V_I = 5.5 V or GND; V_{SW} = GND or V_{CC} ; V_{CC} = 1.65 V to 5.5 V | [2] | - | 0.1 | 10 | - | 200 | μА |
| ΔI_{CC} | additional supply current | pin \overline{E} ; $V_I = V_{CC} - 0.6 \text{ V}$; $V_{SW} = \text{GND or } V_{CC}$; $V_{CC} = 5.5 \text{ V}$ | [2] | - | 5 | 500 | - | 5000 | μΑ |
| C _I | input capacitance | | | - | 2.0 | - | - | - | pF |
| C _{S(OFF)} | OFF-state capacitance | | | - | 5.0 | - | - | - | pF |
| C _{S(ON)} | ON-state capacitance | | | - | 9.5 | - | - | - | pF |

^[1] All typical values are measured at T_{amb} = 25 °C.

^[2] These typical values are measured at V_{CC} = 3.3 V.

10.1 Test circuits



10.2 ON resistance

Table 8. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground 0 V); for graphs see Figure 10 to Figure 15.

| Symbol | Parameter | Conditions | -40 | °C to +8 | 5 °C | –40 °C to | +125 °C | Unit |
|-----------------------|--|--|------|----------|------|-----------|---------|------|
| | | | Min | Typ[1] | Max | Min | Max | |
| R _{ON(peak)} | ON resistance (peak) | $V_I = GND$ to V_{CC} ; see <u>Figure 9</u> | | | | | | |
| | | $I_{SW} = 4 \text{ mA};$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | - | 34.0 | 130 | - | 195 | Ω |
| | I_{SW} = 8 mA; V_{CC} = 2.3 V to 2.7 V | - | 12.0 | 30 | - | 45 | Ω | |
| | | $I_{SW} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | - | 10.4 | 25 | - | 38 | Ω |
| | | I_{SW} = 24 mA; V_{CC} = 3 V to 3.6 V | - | 7.8 | 20 | - | 30 | Ω |
| | | I_{SW} = 32 mA; V_{CC} = 4.5 V to 5.5 V | - | 6.2 | 15 | - | 23 | Ω |
| R _{ON(rail)} | ON resistance (rail) | V _I = GND; see <u>Figure 9</u> | | | | | | |
| | | I _{SW} = 4 mA; V _{CC} = 1.65 V to 1.95 V | - | 8.2 | 18 | - | 27 | Ω |
| | | I_{SW} = 8 mA; V_{CC} = 2.3 V to 2.7 V | - | 7.1 | 16 | - | 24 | Ω |
| | | $I_{SW} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | - | 6.9 | 14 | - | 21 | Ω |
| | | I_{SW} = 24 mA; V_{CC} = 3 V to 3.6 V | - | 6.5 | 12 | - | 18 | Ω |
| | | I_{SW} = 32 mA; V_{CC} = 4.5 V to 5.5 V | - | 5.8 | 10 | - | 15 | Ω |
| | | V _I = V _{CC} ; see <u>Figure 9</u> | | | | - | | |
| | | I _{SW} = 4 mA; V _{CC} = 1.65 V to 1.95 V | - | 10.4 | 30 | - | 45 | Ω |
| | | I_{SW} = 8 mA; V_{CC} = 2.3 V to 2.7 V | - | 7.6 | 20 | - | 30 | Ω |
| | | $I_{SW} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | - | 7.0 | 18 | - | 27 | Ω |
| | | I_{SW} = 24 mA; V_{CC} = 3 V to 3.6 V | - | 6.1 | 15 | - | 23 | Ω |
| | | $I_{SW} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | - | 4.9 | 10 | - | 15 | Ω |

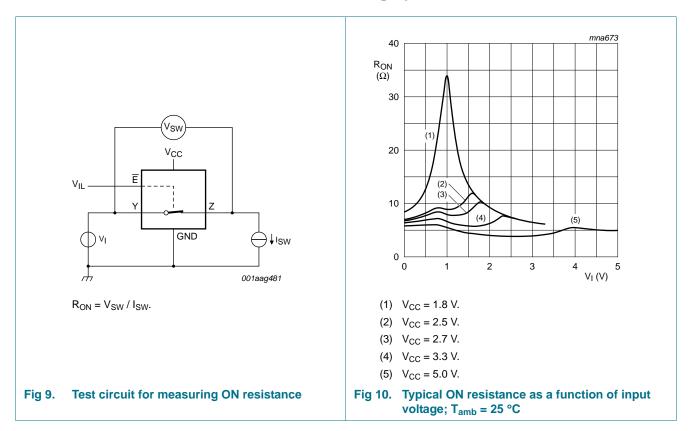
Table 8. ON resistance ... continued

At recommended operating conditions; voltages are referenced to GND (ground 0 V); for graphs see Figure 10 to Figure 15.

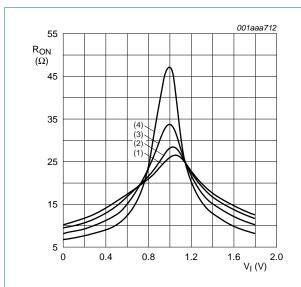
| Symbol | Parameter | Conditions | | -40 | °C to +8 | 5 °C | -40 °C to | +125 °C | Unit |
|----------------|---------------|--|-----|-----|----------|------|-----------|---------|------|
| | | | | Min | Typ[1] | Max | Min | Max | |
| $R_{ON(flat)}$ | ON resistance | $V_I = GND$ to V_{CC} | [2] | | | | | | |
| | (flatness) | $I_{SW} = 4 \text{ mA};$ $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | - | 26.0 | - | - | - | Ω |
| | | I_{SW} = 8 mA; V_{CC} = 2.3 V to 2.7 V | | - | 5.0 | - | - | - | Ω |
| | | $I_{SW} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$ | | - | 3.5 | - | - | - | Ω |
| | | I_{SW} = 24 mA; V_{CC} = 3 V to 3.6 V | | - | 2.0 | - | - | - | Ω |
| | | I_{SW} = 32 mA; V_{CC} = 4.5 V to 5.5 V | | - | 1.5 | - | - | - | Ω |

^[1] Typical values are measured at T_{amb} = 25 °C and nominal V_{CC} .

10.3 ON resistance test circuit and graphs

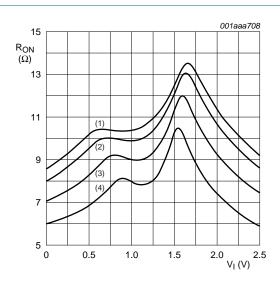


^[2] Flatness is defined as the difference between the maximum and minimum value of ON resistance measured at identical V_{CC} and temperature.



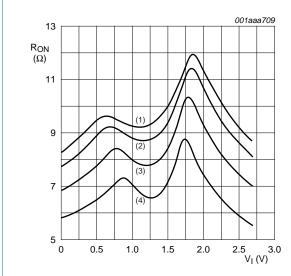
- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 11. ON resistance as a function of input voltage; $V_{CC} = 1.8 \text{ V}$



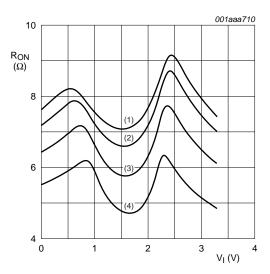
- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 12. ON resistance as a function of input voltage; $V_{CC} = 2.5 \text{ V}$



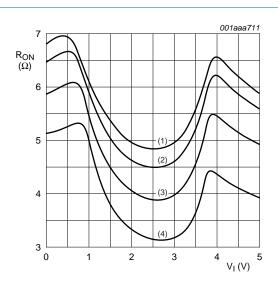
- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 13. ON resistance as a function of input voltage; $V_{CC} = 2.7 \text{ V}$



- (1) $T_{amb} = 125 \,^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 14. ON resistance as a function of input voltage; $V_{CC} = 3.3 \text{ V}$



- (1) $T_{amb} = 125 \, ^{\circ}C$.
- (2) $T_{amb} = 85 \, ^{\circ}C$.
- (3) $T_{amb} = 25 \, ^{\circ}C$.
- (4) $T_{amb} = -40 \, ^{\circ}C$.

Fig 15. ON resistance as a function of input voltage; $V_{CC} = 5.0 \text{ V}$

11. Dynamic characteristics

Table 9. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 18.

| Symbol | Parameter | Conditions | | -40 | °C to +8 | 5 °C | –40 °C to | +125 °C | Unit |
|-----------------|-------------------|--|------------|-----|----------|------|-----------|---------|------|
| | | | | Min | Typ[1] | Max | Min | Max | |
| t _{pd} | propagation delay | Y to Z or Z to Y; see Figure 16 | [2][3] | | | | | | |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | - | 0.8 | 2.0 | - | 3.0 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | - | 0.4 | 1.2 | - | 2.0 | ns |
| | | V _{CC} = 2.7 V | | - | 0.4 | 1.0 | - | 1.5 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | - | 0.3 | 0.8 | - | 1.5 | ns |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | - | 0.2 | 0.6 | - | 1.0 | ns |
| t _{en} | enable time | E to Y or Z; see Figure 17 | <u>[4]</u> | | | | | | |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | | 1.0 | 10.0 | 12.0 | 1.0 | 15.5 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | | 1.0 | 5.7 | 6.5 | 1.0 | 8.5 | ns |
| | | V _{CC} = 2.7 V | | 1.0 | 5.4 | 6.0 | 1.0 | 8.0 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | | 1.0 | 4.8 | 5.0 | 1.0 | 6.5 | ns |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | 1.0 | 3.3 | 4.2 | 1.0 | 5.5 | ns |

Dynamic characteristics ...continued Table 9.

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 18.

| Symbol | Parameter | Conditions | -40 | °C to +8 | 5 °C | –40 °C to | +125 °C | Unit |
|------------------|-------------------------------|---|----------|----------|------|-----------|---------|------|
| | | | Min | Typ[1] | Max | Min | Max | |
| t _{dis} | disable time | E to Y or Z; see Figure 17 | <u>l</u> | ' | | | | • |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | 1.0 | 7.4 | 10.0 | 1.0 | 13.0 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 1.0 | 4.1 | 6.9 | 1.0 | 9.0 | ns |
| | | $V_{CC} = 2.7 \text{ V}$ | 1.0 | 4.9 | 7.5 | 1.0 | 9.5 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 1.0 | 5.4 | 6.5 | 1.0 | 8.5 | ns |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | 1.0 | 3.6 | 5.0 | 1.0 | 6.5 | ns |
| C_{PD} | power dissipation capacitance | $C_L = 50 \text{ pF}; f_i = 10 \text{ MHz};$ $V_I = \text{GND to } V_{CC}$ | l | | | | | |
| | | $V_{CC} = 2.5 \text{ V}$ | - | 13.7 | - | - | - | pF |
| | | V _{CC} = 3.3 V | - | 15.2 | - | - | - | pF |
| | | V _{CC} = 5.0 V | - | 18.3 | - | - | - | pF |

- [1] Typical values are measured at T_{amb} = 25 °C and nominal V_{CC} .
- [2] t_{pd} is the same as t_{PLH} and t_{PHL} .
- propagation delay is the calculated RC time constant of the typical ON resistance of the switch and the specified capacitance when driven by an ideal voltage source (zero output impedance).
- [4] t_{en} is the same as t_{PZH} and t_{PZL} .
- [5] t_{dis} is the same as t_{PLZ} and t_{PHZ} .
- [6] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma \{ (C_L + C_{S(ON)}) \times V_{CC}^2 \times f_o \} \text{ where: }$

f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

C_{S(ON)} = maximum ON-state switch capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

 $\Sigma \{(C_L + C_{S(ON)}) \times V_{CC}^2 \times f_o\} = \text{sum of the outputs.}$

11.1 Waveforms and test circuit

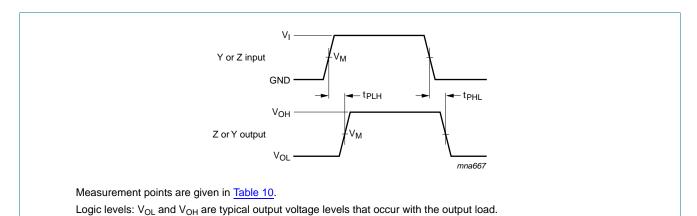


Fig 16. Input (Y or Z) to output (Z or Y) propagation delays

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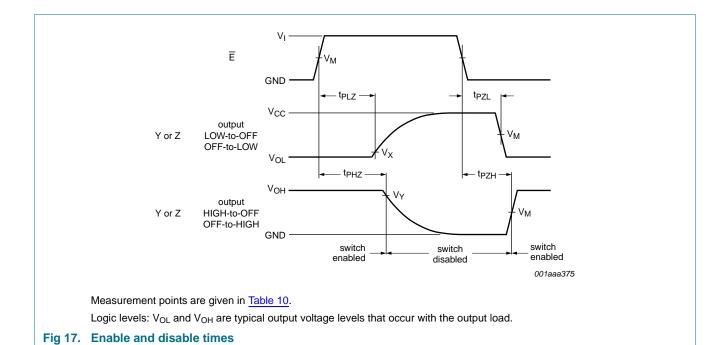
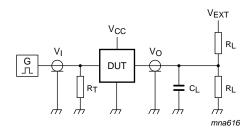


Table 10. Measurement points

| Supply voltage | Input | Output | | | | | | |
|------------------|--------------------|--------------------|--------------------------|--------------------------|--|--|--|--|
| V _{CC} | V _M | V _M | V _X | V _Y | | | | |
| 1.65 V to 1.95 V | 0.5V _{CC} | 0.5V _{CC} | V _{OL} + 0.15 V | $V_{OH} - 0.15 V$ | | | | |
| 2.3 V to 2.7 V | 0.5V _{CC} | 0.5V _{CC} | V _{OL} + 0.15 V | V _{OH} – 0.15 V | | | | |
| 2.7 V | 1.5 V | 1.5 V | $V_{OL} + 0.3 V$ | $V_{OH} - 0.3 V$ | | | | |
| 3.0 V to 3.6 V | 1.5 V | 1.5 V | $V_{OL} + 0.3 V$ | $V_{OH} - 0.3 V$ | | | | |
| 4.5 V to 5.5 V | 0.5V _{CC} | 0.5V _{CC} | $V_{OL} + 0.3 V$ | $V_{OH} - 0.3 V$ | | | | |



Test data is given in Table 11.

Definitions for test circuit:

 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator.

 C_L = Load capacitance including jig and probe capacitance.

 R_L = Load resistance.

 V_{EXT} = External voltage for measuring switching times.

Fig 18. Test circuit for measuring switching times

Table 11. Test data

| Supply voltage | Input | | Load | Load | | V _{EXT} | | |
|------------------|----------|---------------------------------|-------|----------------|-------------------------------------|-------------------------------------|-------------------------------------|--|
| V _{CC} | VI | t _r , t _f | CL | R _L | t _{PLH} , t _{PHL} | t _{PZH} , t _{PHZ} | t _{PZL} , t _{PLZ} | |
| 1.65 V to 1.95 V | V_{CC} | \leq 2.0 ns | 30 pF | 1 kΩ | open | GND | 2V _{CC} | |
| 2.3 V to 2.7 V | V_{CC} | ≤ 2.0 ns | 30 pF | 500Ω | open | GND | 2V _{CC} | |
| 2.7 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500Ω | open | GND | 6 V | |
| 3.0 V to 3.6 V | 2.7 V | ≤ 2.5 ns | 50 pF | 500 Ω | open | GND | 6 V | |
| 4.5 V to 5.5 V | V_{CC} | ≤ 2.5 ns | 50 pF | 500Ω | open | GND | 2V _{CC} | |

11.2 Additional dynamic characteristics

Table 12. Additional dynamic characteristics

At recommended operating conditions; typical values measured at T_{amb} = 25 °C.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|--------|---------------------------|---|-------|-------|-----|------|
| THD | total harmonic distortion | $R_L = 10 \text{ k}\Omega; C_L = 50 \text{ pF}; f_i = 1 \text{ kHz};$ see Figure 19 | | | | |
| | | V _{CC} = 1.65 V | - | 0.032 | - | % |
| | | V _{CC} = 2.3 V | - | 0.008 | - | % |
| | $V_{CC} = 3.0 \text{ V}$ | - | 0.006 | - | % | |
| | | V _{CC} = 4.5 V | - | 0.001 | - | % |
| | | R_L = 10 k Ω ; C_L = 50 pF; f_i = 10 kHz; see Figure 19 | | | | |
| | | V _{CC} = 1.65 V | - | 0.068 | - | % |
| | | V _{CC} = 2.3 V | - | 0.009 | - | % |
| | | V _{CC} = 3.0 V | - | 0.008 | - | % |
| | | V _{CC} = 4.5 V | - | 0.006 | - | % |

 Table 12.
 Additional dynamic characteristics ...continued

At recommended operating conditions; typical values measured at T_{amb} = 25 °C.

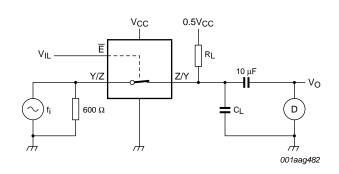
| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|--------------------------|---|-----|-------|-----|------|
| f _(-3dB) | -3 dB frequency response | $R_L = 600 \Omega$; $C_L = 50 pF$; see Figure 20 | | | | |
| | | V _{CC} = 1.65 V | - | 135 | - | MHz |
| | | V _{CC} = 2.3 V | - | 145 | - | MHz |
| | | V _{CC} = 3.0 V | - | 150 | - | MHz |
| | | V _{CC} = 4.5 V | - | 155 | - | MHz |
| | | $R_L = 50 \Omega$; $C_L = 5 pF$; see Figure 20 | | | | |
| | | V _{CC} = 1.65 V | - | > 500 | - | MHz |
| | | V _{CC} = 2.3 V | - | > 500 | - | MHz |
| | | V _{CC} = 3.0 V | - | > 500 | - | MHz |
| | | V _{CC} = 4.5 V | - | > 500 | - | MHz |
| | | $R_L = 50 \Omega$; $C_L = 10 pF$; see Figure 20 | | | | |
| | | V _{CC} = 1.65 V | - | 200 | - | MHz |
| | | $V_{CC} = 2.3 \text{ V}$ | - | 350 | - | MHz |
| | | V _{CC} = 3.0 V | - | 410 | - | MHz |
| | | V _{CC} = 4.5 V | - | 440 | - | MHz |
| α_{iso} | isolation (OFF-state) | R_L = 600 Ω ; C_L = 50 pF; f_i = 1 MHz; see Figure 21 | | | | |
| | | V _{CC} = 1.65 V | - | -46 | - | dB |
| | | V _{CC} = 2.3 V | - | -46 | - | dB |
| | | V _{CC} = 3.0 V | - | -46 | - | dB |
| | | V _{CC} = 4.5 V | - | -46 | - | dB |
| | | $R_L = 50 \Omega$; $C_L = 5 pF$; $f_i = 1 MHz$; see Figure 21 | | | | |
| | | V _{CC} = 1.65 V | - | -37 | - | dB |
| | | $V_{CC} = 2.3 \text{ V}$ | - | -37 | - | dB |
| | | V _{CC} = 3.0 V | - | -37 | - | dB |
| | | V _{CC} = 4.5 V | - | -37 | - | dB |
| V _{ct} | crosstalk voltage | between digital input and switch; | | | | |
| | | R_L = 600 Ω ; C_L = 50 pF; f_i = 1 MHz; t_r = t_f = 2 ns; see <u>Figure 22</u> | | | | |
| | | V _{CC} = 1.65 V | - | 69 | - | mV |
| | | $V_{CC} = 2.3 \text{ V}$ | - | 87 | - | mV |
| | | V _{CC} = 3.0 V | - | 156 | - | mV |
| | | V _{CC} = 4.5 V | - | 302 | - | mV |

 Table 12.
 Additional dynamic characteristics ...continued

At recommended operating conditions; typical values measured at T_{amb} = 25 °C.

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-----------------------------------|-------------------------|--|-----|-----|-----|------|
| Q _{inj} charge injection | charge injection | C_L = 0.1 nF; V_{gen} = 0 V; R_{gen} = 0 Ω ; f_i = 1 MHz; R_L = 1 M Ω ; see Section 11 | | | | |
| | V _{CC} = 1.8 V | - | 3.3 | - | рС | |
| | V _{CC} = 2.5 V | - | 4.1 | - | рC | |
| | | V _{CC} = 3.3 V | - | 5.0 | - | рС |
| | | V _{CC} = 4.5 V | - | 6.4 | - | рС |
| | | V _{CC} = 5.5 V | - | 7.5 | - | рС |

11.3 Test circuits



Test conditions:

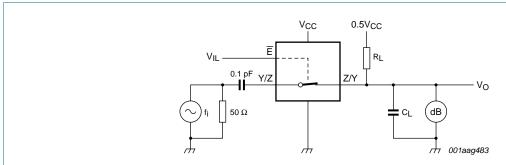
 $V_{CC} = 1.65 \text{ V: } V_I = 1.4 \text{ V (p-p)}.$

 $V_{CC} = 2.3 \text{ V: } V_I = 2 \text{ V (p-p)}.$

 $V_{CC} = 3 \text{ V: } V_{I} = 2.5 \text{ V (p-p)}.$

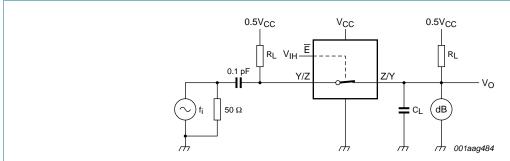
 $V_{CC} = 4.5 \text{ V: } V_I = 4 \text{ V (p-p)}.$

Fig 19. Test circuit for measuring total harmonic distortion



Adjust f_i voltage to obtain 0 dBm level at output. Increase f_i frequency until dB meter reads –3 dB.

Fig 20. Test circuit for measuring the frequency response when switch is in ON-state



Adjust fi voltage to obtain 0 dBm level at input.

Fig 21. Test circuit for measuring isolation (OFF-state)

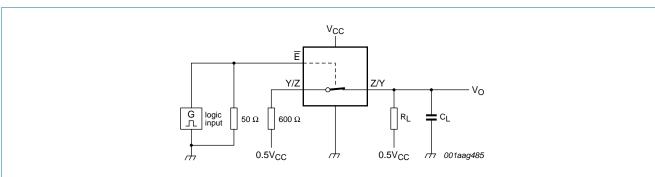
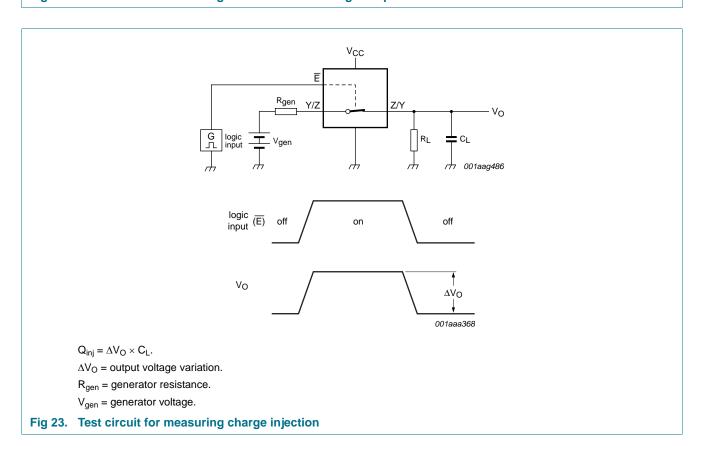


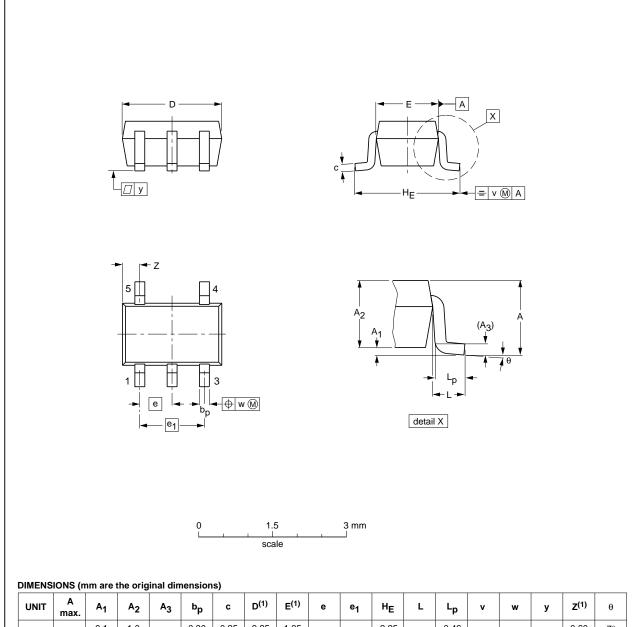
Fig 22. Test circuit for measuring crosstalk between digital inputs and switch



12. Package outline

TSSOP5: plastic thin shrink small outline package; 5 leads; body width 1.25 mm

SOT353-1



| UNIT | A max. | A ₁ | A ₂ | A ₃ | bp | С | D ⁽¹⁾ | E ⁽¹⁾ | е | e ₁ | HE | L | Lp | v | w | у | Z ⁽¹⁾ | θ |
|------|-----------|----------------|----------------|----------------|--------------|--------------|------------------|------------------|------|----------------|-------------|-------|--------------|-----|-----|-----|------------------|----------|
| mm | 1.1 | 0.1 0 | 1.0 0.8 | 0.15 | 0.30 0.15 | 0.25 0.08 | 2.25 1.85 | 1.35 1.15 | 0.65 | 1.3 | 2.25 2.0 | 0.425 | 0.46 0.21 | 0.3 | 0.1 | 0.1 | 0.60 0.15 | 7° 0° |

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

| | REFER | RENCES | | EUROPEAN | ISSUE DATE |
|-----|--------|-----------|-----------------|-----------------|-----------------------------------|
| IEC | JEDEC | JEITA | | PROJECTION | 1330E DATE |
| | MO-203 | SC-88A | | | -00-09-01- 03-02-19 |
| _ | IEC | IEC JEDEC | IEC JEDEC JEITA | IEC JEDEC JEITA | IEC JEDEC JEITA PROJECTION |

Fig 24. Package outline SOT353-1 (TSSOP5)

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Plastic surface-mounted package; 5 leads

SOT753

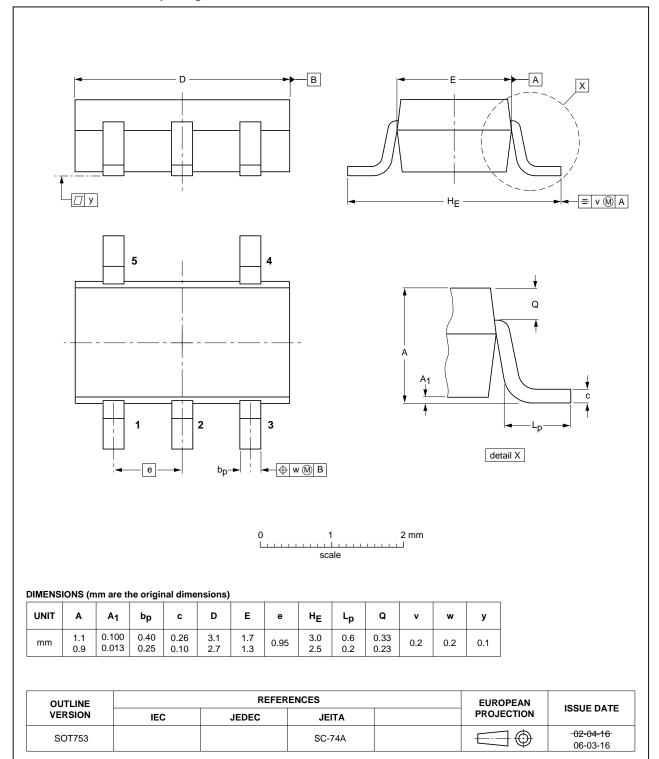


Fig 25. Package outline SOT753 (SC-74A)

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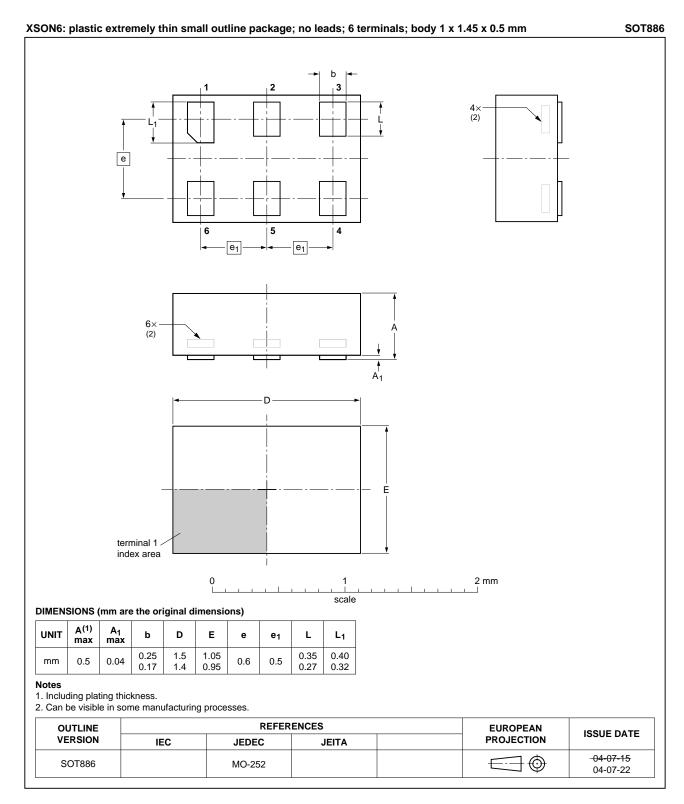


Fig 26. Package outline SOT886 (XSON6)

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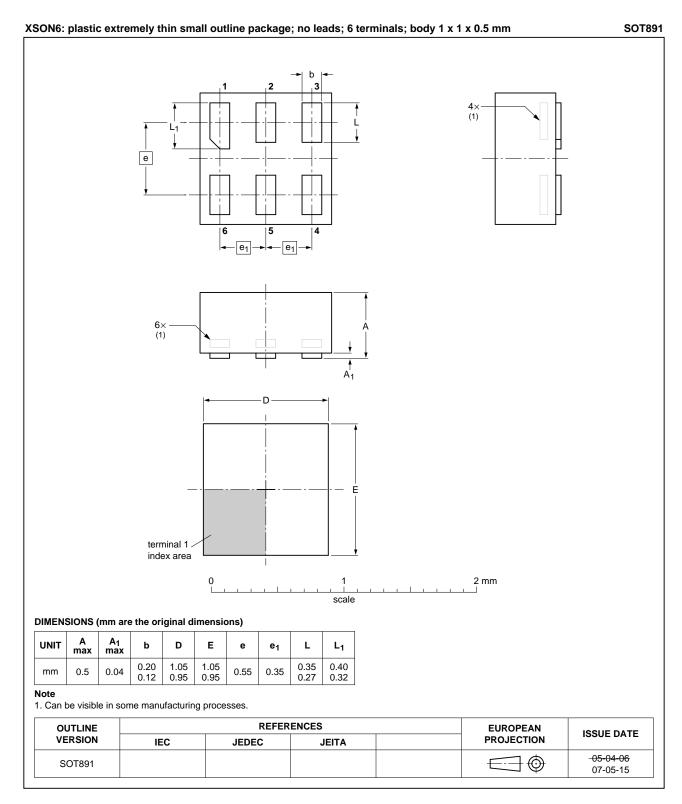


Fig 27. Package outline SOT891 (XSON6)

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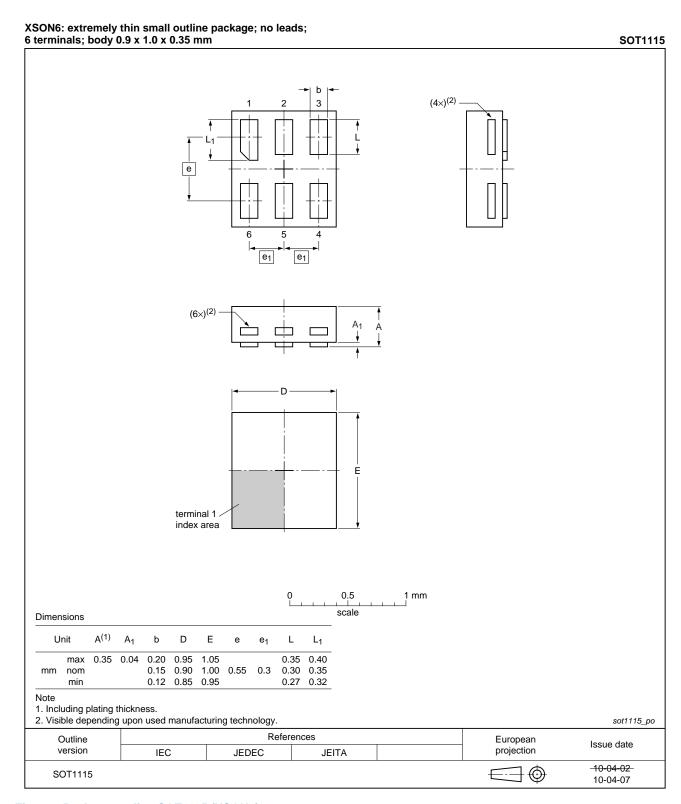


Fig 28. Package outline SOT1115 (XSON6)

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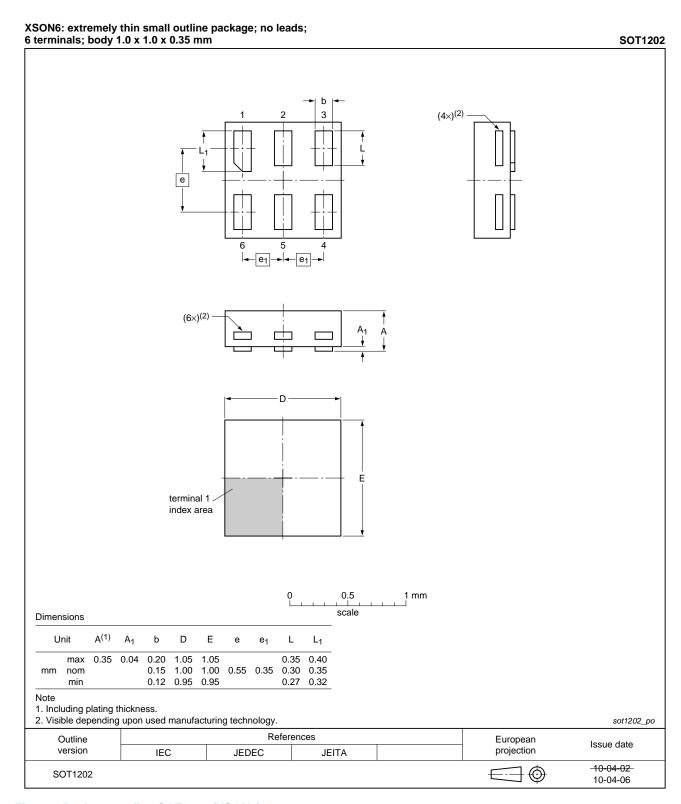


Fig 29. Package outline SOT1202 (XSON6)

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13. Abbreviations

Table 13. Abbreviations

| Acronym | Description |
|---------|---|
| CMOS | Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| НВМ | Human Body Model |
| MM | Machine Model |
| TTL | Transistor-Transistor Logic |

14. Revision history

Table 14. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|---------------------------------|--------------------|---------------|----------------|
| 74LVC1G384 v.4 | 20111206 | Product data sheet | - | 74LVC1G384 v.3 |
| Modifications: | Legal pages | updated. | | |
| 74LVC1G384 v.3 | 20101103 | Product data sheet | - | 74LVC1G384 v.2 |
| 74LVC1G384 v.2 | 20070829 | Product data sheet | - | 74LVC1G384 v.1 |
| 74LVC1G384 v.1 | 20040226 | Product data | - | - |

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|--------------------------------|-------------------|---|
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| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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- [2] The term 'short data sheet' is explained in section "Definitions"
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